GPS2020

SVChip A Lucent Technologies Venture

SyChip GPS2020 Product Brief

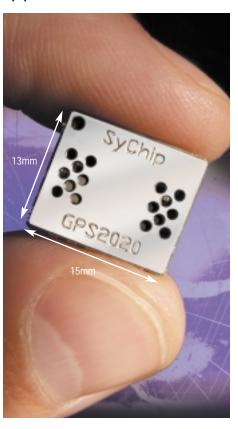
Global positioning system receiver for wireless internet appliances

SyChip, A Lucent Technologies new venture, introduces the GPS2020, one of the smallest Global Positioning System (GPS) receivers ever built: 13mm x 15mm area. Designed for wireless communication applications, the GPS2020 is aimed at enabling wireless location based services in cellular phones, palm-top computers and notebook computers. This module also represents a full fledged geolocation solution that enables US cellular phones to comply with the FCC E-911 Phase 2 mandate within the given timeframe.

Based on the Micro System Integration Technologies from Bell Laboratories, this GPS chip scale module is smaller and consumes less power than traditional PCB solutions. The small form factor allows the designers of Wireless Internet Appliances, (i.e. cellular phones, palmtop computers, etc., as well as other vertical applications), the ability to access GPS data with minimal impact on existing system designs. The module has low power consumption, high signal sensitivity, and all the attributes of a larger sized system.

The GPS2020 module contains two integrated circuits: an RF receiver and a Baseband processor. The latter includes an ARM processor core and a DSP engine. It is capable of retrieving all the necessary GPS data and provides a complete navigation solution (NMEA or SiRF binary) through the serial port. Customers will have plenty of space for their firmware since the system contains 8 Mbit of Flash memory. SyChip's highly integrated sub-system module resolves the key difficulties faced by designers in implementing GPS using a discrete chip set solution. By providing a fully tested module, SyChip also eliminates cost and schedule challenges faced by Wireless Internet Appliance manufacturers.

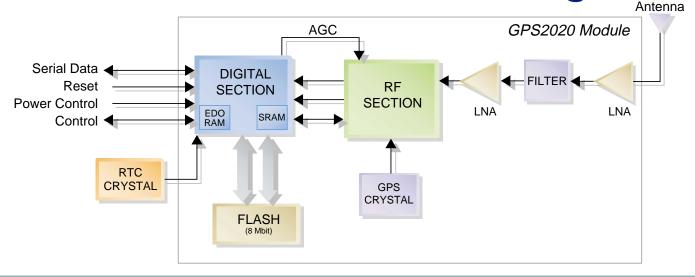
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Features and Benefits

- Very small size:13mm x 15mm x 3.75mm
- Complete GPS functionality
- 12 Channel Receiver
- Baseband RF integrated module
- 8 Mbit Flash Memory and ARM Processor are available for customer application

GPS Module Block Diagram



Specifications* (SiRFStarII powered)





- Power Supply Voltage
- Temperature Range
- Antenna Input
- GPS Channels
- Update Rate
- Cold Start
- Warm Start
- Hot Start
- Reacquisition Time
- Minimum Signal
- Maximum Speed
- Maximum Altitude
- Trickle State Current
- CPU state Current
- Tracking State Current
- Position Accuracy
- Dimensions

3.3V

-40°C to +85°C

50 Ohms

12

1Hz

45 sec

38 sec

8 sec

100 millisec

-140 dBm

1852 km/h 18300 m

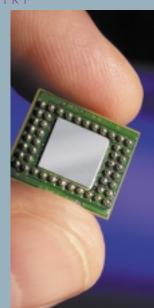
1 mA

30 mA

145 mA

15 m (2d RMS, SA off)

13mm x 15mm x 3.75mm**



- * Specifications are subject to change without notice.
- ** Height as measured after mounting.

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